IPC ASSOCIATION CON	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				s Materials	ials and Mfg Information			
upplier In	nformation	-												
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
nsemi										2	2025-06-09			
Contact Name	e	Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-	-Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
uthorized Re	epresentative*	Title - Representative			I	Phone - Representative*			E	Email - Representative*				
Product-Env-	-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
Re	Requester Item Number Mf		fr Item Number Mfr Item Name				Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
		NCH-RSL15-512- 101Q40-ACG RSL15 QFN 512kB		В		2025-06-09	6-09 TWU			68.7615	mg	Each		
Ianufactu	ring Proccess Inform	ation												
Ter	Terminal Plating / Grid Array Material Term			erminal Base Alloy J-STD-020 MSL		Rating	Peak Process Body Temperature Max Time at 1			at Peak Te	eak Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed		CU Alloy 3				260	C	30		seconds 3				
omments														
<b>TENTION</b>	: MSL 3 Rated item requir	es Bake and D	ry Pack (afte	er electrical test)										
or more info	rmation regarding materia	l composition	please refer t	to page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier supplier has not independently verified information provided by others, supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.8409	mg	Supplier	Silicon (Si)	7440-21-3		2.8409	mg
Die Attach	0.7341	_	Supplier	Silver (Ag)	7440-22-4		0.624	mg
			Supplier	Acrylic resins	Proprietary Data		0.1101	mg
Lead Frame	29.4757		Supplier	Silver (Ag)	7440-22-4		0.3213	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0354	mg
			Supplier	Iron (Fe)	7439-89-6		0.6838	mg
			Supplier	Copper (Cu)	7440-50-8		28.4264	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0088	mg
Mold Compound-Black	33.0806			Epoxy resin	proprietary data		1.654	mg
			Supplier	Phenolic Resin	Proprietary Data		0.7609	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.654	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1323	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7609	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		28.1185	mg
Plating	2.1313	mg	Supplier	Tin (Sn)	7440-31-5		2.1313	mg
Wire Bond - Au	0.4989	mg	Supplier	Gold (Au)	7440-57-5		0.4989	mg